Two-Phase Cooling of Targets and Electronics for Particle Physics Experiments **Prof. John R. Thome** 

**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

**Laboratory of Heat and Mass Transfer Faculty of Engineering Science** Ecole Polytechnique Fédérale de Lausanne **Lausanne, Switzerland** 

**Fermilab, Chicago: January 20, 2010** 

#### **Overview of Lecture, Topics and Sponsors: ,p p**

#### **Topics to be Addressed:**

- **Overview of two-phase cooling of electronics and computer chips.**
- **Videos of boiling in multi-microchannel cooling elements.**
- **Flow patterns in microchannels.**

**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

- **Design considerations to make two-phase cooling work.**
- **Heat transfer in a silicon cooling element with microchannels.**
- Comparisons of two-phase vs. single-phase cooling of *targets*.

**Sponsors of Microscale Two-Phase Flow and Heat Transfer at LTCM: Swiss National Science Foundatin, Swiss CTI agency, IBM, ABB, European Madame Curie, European Space Agency, etc.**



H

**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

**GPAL** 



### **Who is the EPFL?: 2009 Shanghai Rankings in Engineering**

H

**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

**CPAL** 



#### **Brief Description of LTCM Laboratory**

#### **Staff: (about 21 researchers not counting M.S. students)**

• **currently 14 Ph.D. Students and 3 M.S. students.**

**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

- **6 post-doctoral reseachers.**
- **2 technicians available more or less full time from pool.**
- **1 prof. plus 2 secretaries.**

#### **Test facilities: (***all with flow visualization***)**

**One multi-channel microscale flow boiling test facility; Second multi-channel microscale flow** boiling facility at **IBM** (CH); **One single-channel microscale flow boiling test facility; One multi-microchannel condensing test facitity; Air-water micro water micro-channel and macro channel macro-channel test facilities; channel One macrochannel flow boiling test facility for macroscale flows; One falling film boiling and condensation test facility; One tube bundle boiling test facility; One micro-PIV test setup to measure velocity profiles in one/two-phase flows;**

**3 high speed digital cameras (one up to 120k Hz) and 3 IR cameras.** 



**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

*Engineering Data Book III* :

**<sup>a</sup> free <sup>e</sup> e-book at website book**

#### **www.wlv.com**

**Then go to the online book page. It includes 20 chapters on micro and macro scale single-phase and two-phase flow and heat transfer, over 200 videos in Chapter 1, an Excel calculation program, etc.**

# **Desired Attributes of CO2 Two-Phase Target Cooler Two Phase Cooler**

- **Low mass cooler (use microchannels in silicon)**
- **√Low mass of coolant (two-phase fluid achieves this)**
- **Remove heat effectively (high h.t.c. for boiling fluid)**
- **Temperature uniformity (achievable)**

**ECOLE POLYTECHNIQUEFEDERALE DE LAUSANNE**

- **Cool hotspots (achievable)**
- **Stable flow (achievable** *but* **requires dedicated attention)**
- **Handle transient heat fluxes (okay but requires study)**
- **Handle low temperatures (no problem for CO2)**
- **Work at lo press res (not feasible ith CO2) low pressures (not feasible with**
- **Use stable non-corrosive fluid with long life (CO2 is fine)**
- **Very thin cooler design (channel heights limited) limited)**



**Left: Pump-based system; based Right: Compressor Compressor-based system based system. EAV refers to electronic actuated valve, AER refers to accumulator, heat exchanger and receiver components.**

## **Models Required for Design of Micro-Evaporators Micro Evaporators**

¾**Flow boiling model and flow pattern map: LTCM has 3-zone model and flow map.**

**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

- ¾**Two-phase pressure drop and void fraction models for microchannels: Must cover laminar, transition and turbulent regimes for circular and rectangular channel shapes. LTCM has 1-d turbulence model for annular microchannel flows.**
- ¾**CHF model for circular/non-circular, single and multi-channel heat sinks: LTCM has theoretical and empirical method methods and is improving them.**
- ¾**Stable two-phase flow with large scale instabilities: LTCM has method that stabilizes flow in our test sections with up to 134 parallel channels.**
- > 3-d numerical modeling of conduction in heat sinks: commercial codes are okay.
- ¾**Temperature overshoots at startup: LTCM has limited data and a passive method to avoid overshoot, and has patented an active method to avoid them.**
- $\triangleright$  Numerical model to simulate distribution of single and two-phase flows in the inlet **and outlet headers: LTCM is working on this.**
- ¾**Transient simulation capability and hot spots: LTCM has limited data on first**  topic; has first method to simulate CHF at hot spots and just now first data too.
- ¾ **Comprehensive simulation tool has been developed within LTCM.**

**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

#### **Backflow/Instability in Parallel Microchannels:**

**Qu and Mudawar (P d ur ue) diagram: backflow intoinlet header, flow maldistribution and unstable flow.** *Needs solution!*





# **CPU Microchannel Flow Boiling Cooling at LTCM Cooling**

**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**



**Multi-microchannel crochannel evaporator incopper fabricated abricatedat LTCM: 20 channels (0.45 x 4.0 mm) and dissipates 340 W/cm2 with a low pressure refrigerant as coolant (***LTCM PhD thesis of J.E. Park (2008***).**

#### **Video at High Heat Flux in Copper: Poor Flow Distribution**



**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

**AVA** 

**Maximum heat flux dissipation possible is only about 115 W/cm2 (as a result of mal-distribution and b k fl d back flow, there is over heating in liquid starved/ dry area!). Video of LTCM.** 

IY.



#### **Video at High Heat Flux in Copper: Good Flow Distribution**

2000 i/s 1/12500 sec +00:00:00.000000sec Tout=21C  $Tir = 10C$ G=650kg/m2s Q=250W/cm2 Fluid=R134a

**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

**APA** 

**Maximum heat flux dissipation possible is at least 340 W/cm2 using inlet flow restrictions to prevent back flow and createuniform flow distribution (sho <sup>n</sup> here at (shown 250 W/cm2 at 2000 images/sec). Vid f LTCM Video of LTCM.**



**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

**Flow Patterns in a 0.5 mm Diameter Channel: Videos at exit of microchannel &boiling data from Consolini Ph.D. thesis at EPFL (2008). g ( )**









# **Analysis of CHF of Hotspots on Computer Chips**



**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

**Revellin-Thome (2007): 1-d ( ) numerical model applied to prediction of local CHF at hotspots in micro micro-channels with channels micro-scale boiling.**



(e)  $q_{\text{HS}} = q_{\text{HS, max}} = 3000 \text{ kW/m}^2$ . Dryout occurs at the hot spot location.

**Hot spot heat flux as a function of the hot spot size located at the midpoint along the circular microchannel for**  $D=0.5$  **mm,**  $G=500$  **kg/m<sup>2</sup>s,**  $T_{\text{sat}} = 30^{\circ} \text{C}$ ,  $L_{\text{MEV}} = 20 \text{ mm}$  and the local hot spot **situated at the midpoint along the microchannel.** 

#### **Local time averaged heat transfer flow boiling model boiling**



**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

**Three-zone flow boiling model of Thome, Jacobi and Dupont: time averaging of dynamic heat transfer coefficients gives local heat transfer coefficient (7 fluids from 7 labs in original data base, now 5 more fluids).**

**(***i I JH M in Int. J. Heat Mass Transfer, 2004***)**



 $\mathsf{L}_{\mathsf{p}}$  $\mathsf{L}_{\mathsf{v}}$ 

 $\mathbf{L}$ 





**transfer coefficients go over 100'000 W/m2k using a refrigerant, not water.**



**Above graph shows some local base temperatures at various heat fluxes with one inlet and two outlets (up to 256 W/cm2). CHF not reached with this test section with 134 channels. Notice the nearly uniform, low temperatures that can be achieved.**







# **M.S. Thesis of Madhour: Test Section & Results**

 $4.5$ 

 $\overline{4}$ 

 $3.5$ 

3

 $2.5$ 

 $\overline{2}$ 

 $1.5$ 

2

3

4



**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

**Footprint heat transfer coefficient map [W/m2K]. Mass velocity of 1000 kg/m2s,** *qb* **<sup>=</sup> 184 W/cm2**.

**Heater chip surface temperature map [K]. Mass velocity of 900 kg/m2s,** *qb* **<sup>=</sup> 182 W/cm2 .**

 $\overline{4}$ 

5

6

 $\overline{7}$ 

358

357.5

357

356.5

356

355.5

355

354.5

354

353.5



# **Simulation of Micro-Evaporator Performance of CERN GigaTracKer: Geometry and Dimensions**



**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

#### **Parametric study**

**In all cases, the base thickness,** *<sup>e</sup>***, will be zero, thus showing a best-case scenario as any additional material added can be accounted for in separate calculations.** 

**The GTK should not see a temperature difference along its length of more than 5˚C while being kept as cold as possible (~ -30˚C).** 

**Assumptions made for the present simulations are: (***1***) the evaporator is uniformly**  heated from the bottom with a base heat flux of  $q_{_b},$  (2) the flow through the cooler is **uniformly distributed between all the channels, (***3***) the top of the cooler is adiabatic and (***4***) for two-phase flow, no inlet subcooling is used. Cooler is 60mm by 30mm long.** 

# **Simulations for Development of CERN GigaTracKer**

**The models used for single-phase heat transfer and pressure drop are those from Shah and London, while the three-zone model and homogeneous model**  were used for the two-phase heat transfer and pressure drop, respectively.

The fluids to be simulated are radiation-hard fluorocarbons and CO<sub>2</sub>:

**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

 $\bullet$ For temperatures below -10°C, the best choice of fluid would be between  $\text{CO}_2$  and  $\text{C}_2\text{F}_6$  but possibly also  $\text{C}_3\text{F}_8$ .

 $\bullet$ The most common cooling fluid used at CERN is  $\mathrm{C_6F_{14}}$  and is used in singlephase flows only. This fluid is not ideal for two-phase cooling as it is a low**pressure fluid, having a saturation temperature of 56˚C at atmospheric pressure, implying that the system would need to be under vacuum for lower**  temperatures. This has the disadvantage that one is limited by the allowable **pressure drop within the cooling device, implying that channels should be relatively large. The potential of air also leaking into the system becomes greater.** 

 $^*$  Thus, for two-phase cooling:  $\mathbf{CO}_{2}$ ,  $\mathbf{C_{2}F_{6}}$  and  $\mathbf{C_{3}F_{8}}$  will be compared.



Figure 7: Effect of channel width and fin height on maximum base temperature *difference relative to the inlet* and on *pressure drop* for single-phase flow using  $C_6F_{14}$ **relative to 50 microns width or height for fixed fin thickness of 25 microns.**



Figure 9: Effect of fin height on maximum base temperature difference relative to *inlet* **and on** *pressure drop* **for two-phase flow for channel width of 50 microns and fin thickness of 25 microns. Simulation shows that CO2 is the best candidate.**



**The pressures are shown in terms of the ratio of the local pressure to the inlet pressure. The actual base temperature varies depending on the heat transfer/pressure drop/vapor pressure curve of the fluid. Smallest temp. variation is for CO<sub>2</sub>. Pressure drops are also**  $\bf s$ ignificantly less for  $\bf CO_2$  and  $\bf C_2\bf F_6$  since their viscosities are about half that of  $\bf C_3\bf F_8$ .



Figure  $10$  shows a comparison of single-phase to two-phase cooling. Both single-phase  $\mathrm{C6F_{14}}$  and twophase fluid CO, have an inlet temperature of  $-30^{\circ}$ C. The fin height and channel width were 50  $\mu$ m, **while the fin thickness was 25 µm. A base heat flux of 2 W/cm2 was applied. The actual junction/base temperature and fluid pressure along the channel are shown.**

### **Comparison of Single Single-Phase to Two Phase Two-Phase Cooler Phase**

**For both the single-phase and two-phase results, the axial temperature difference is below 5K, although the increase in temperature for the twophase fluid is much less than for the single-phase fluid (0.14K vs. 4.7K).**

**The difference in the fluids' pressure drops is even more significant:** 

**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

\* The single-phase fluid requires a mass flux of  $4500 \text{ kg/m}^2\text{s}$  to obtain a **temperature difference below 5K with a pressure drop of about 700 kPa!** 

**\* The two-phase fluid only required a mass flux of 250 kg/m2s that resulted in a pressure drop of 60 kPa.** 

**The power required to move the two fluids is 1984 mW and 28 mW,**   $\bf$  **respectively.** 

**Simulation implies that CO2 two-phase cooling relative to C6F14 singlephase cooling yields much lower axial temperature gradients in the GTK,**  lower pressure drops and pumping power consumption, and very high heat **transfer coefficients but is more complex to implement.**





# *CMOSAIC***: 3D-IC Thermal Performance with 3D IC Microscale Liquid/Evaporative Cooling**

- **<b>P** A 3D computer chip with integrated cooling system is expected to:
	- *Overcome the limits of air cooling*
	- *Compress ~1012 nanometer sized functional units (1 Tera) into one cubic centimeter: nearing the equivalent in human brain*
	- *Yield 10 to 100 fold higher connectivity*

**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

- *Cut energy consumption*





*A new \$4.3million Swiss consortium project lead by Prof. Thome*



#### **ECOLE POLYTECHNIQUEFEDERALE DE LAUSANNE**

# **Summary and Advantages:**

**Flow boiling in micro-evaporator elements is a convincing solution for cooling high energy physics targets and haifed**<br>**highamic in micro-evaporator elements is a**<br>**h** for cooling high energy physics target **electronics rather than a viscous liquid because:**

- **It yields much larger heat transfer coefficients larger coefficients,**
- **It makes low temperature difference operation possible,**
- **It has high critical heat fluxes for high W/cm2 g g op , eration,**
- **It provides a near uniform temperature of cooled element,**
- **Hot spot cooling is self-compensated by boiling itself,**
- **It h l i i l has lower pumping power vs. single-ph li ase cooling,**
- **Evaporation at -20°C to -30°C is not a problem,**
- **But two-phase cooling phase is more complex to implement** *but* **we have significant experience with it.**

**Two-Phase Flow in T-Junction:**

**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

- **1. VOF (step one)**
- **2 VOF ith l l t ( t t ) 2. VOF with level set (step two)**
- **3. Other improvements (step three)**
- **4. Validation**

**Thi i i Ph D th i d h This is an ongoing Ph.D. thesis and hence are preliminary results. Written within** *Fluent***.**





**Static conditions without vapor shear. Left: reference system and nomenclature;**  Right: example of solutions obtained for equilateral triangle and rectangle with R-22 fluid, saturation temperature  $T_{sat} = 30^{\circ}$ C, cross sectional void fraction  $\varepsilon$ =0.8, gravity **acceleration g=9.81 m/s2.** 

# **Film Condensation: Microchannel without Vapor Shear**

**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**



**Annular flow without vapor shear. Left: mean heat transfer coefficient (h) versus cross sectional void fraction (e) for circular channels with different hydraulic diameters, different imposed** Δ**T at the wall and different levels of gravity; Right: mean heat transfer coefficient for different test section shapes with hydraulic diameter of 1mm,** Δ**T**   $= 0.5$  K, g=9.81 m/s<sup>2</sup>; the test fluid is HFE7100 in all the cases.

#### **Microscale Flow and Heat Transfer Course:**

**FUNDAMENTALS OF MICROSCALEHEAT TRANSFERMENTALS OF MICRO**<br>HEAT TRANSFER: **BOILING, CONDENSATION, SINGLE-AND TWO TWO-PHASE FLOWS PHASE**

**Date: June 7 7-11 2010 at EPFL in Lausanne 11, Lausanne.**

**Contact: john.thome@epfl.ch**

**ECOLE POLYTECHNIQUE FEDERALE DE LAUSANNE**

*Lecturers***: Thome (EPFL), Michel (IBM Research),**  $C$  **Celata** (**ENEA**), **Zun** (Univ. of Ljubljana), **Jacobi (Univ. of Illinois).**